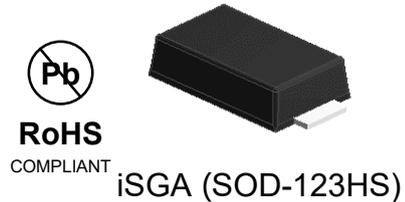


3A,50-60V Schottky Barrier Rectifiers

Features

- Low leakage current
- Schottky barrier diodes
- Low forward voltage drop
- Moisture sensitivity: level 1, per J-STD-020
- Halogen-free according to IEC 61249-2-21 definition
- High temperature soldering guaranteed: 260°C/10 seconds



Applications

For use in low voltage, high frequency inverters, free-wheeling and polarity protection application.

Maximum Ratings & Electrical Characteristics (T _A =25°C unless otherwise noted)				
Parameter	Symbol	PS35	PS36	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	50	60	V
Maximum RMS voltage	V _{RMS}	35	42	V
Maximum DC blocking voltage	V _{DC}	50	60	V
Maximum average forward rectified current	I _{F(AV)}	3		A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load per diode	I _{FSM}	100		A
Operating junction temperature range	T _J	-55 to +150		°C
Storage temperature range	T _{STG}	-55 to +150		°C

Thermal-Mechanical Specifications (T _A =25°C unless otherwise noted)			
Parameter	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient	R _{θJA}	60	°C / W
Thermal Resistance, Junction to Case	R _{θJC}	28	°C / W
Thermal Resistance, Junction to Lead	R _{θJL}	6	°C / W

Electrical Specifications ($T_A=25^{\circ}\text{C}$ unless otherwise noted)					
Parameter	Symbol	Test Conditions	Typ	Max	Unit
Forward Drop Voltage	V_F	$I_F=3\text{A}$ $T_A=25^{\circ}\text{C}$	0.61	0.65	V
		$I_F=3\text{A}$ $T_A=125^{\circ}\text{C}$	0.52	0.60	
Reverse leakage current @ V_R	I_R	$T_J=25^{\circ}\text{C}$	4.1	50	μA
		$T_J=125^{\circ}\text{C}$	3.8	10	mA
Typical junction capacitance	C_J	4.0 V 1 MHz	160		pF

Note:

1. The thermal resistance from junction to ambient or lead, mounted on copper pad area of 5.0 x 5.0mm to each terminal.
2. The thermal resistance from junction to case, mounted on recommended copper pad to each terminal.

Ratings and Characteristics Curves

($T_A = 25^\circ\text{C}$ unless otherwise noted)

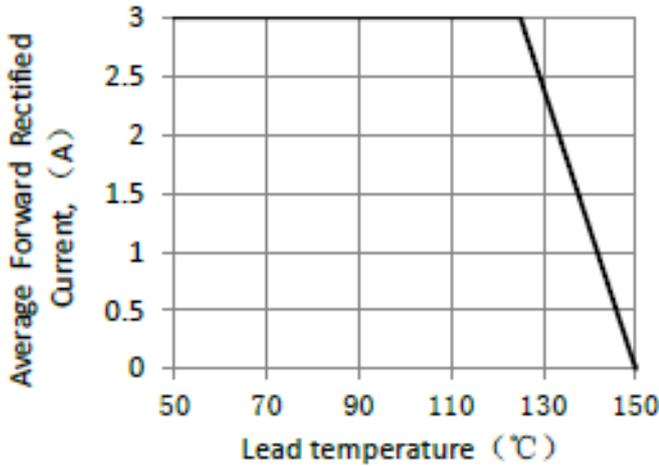


Figure 1. Forward Current Derating Curve

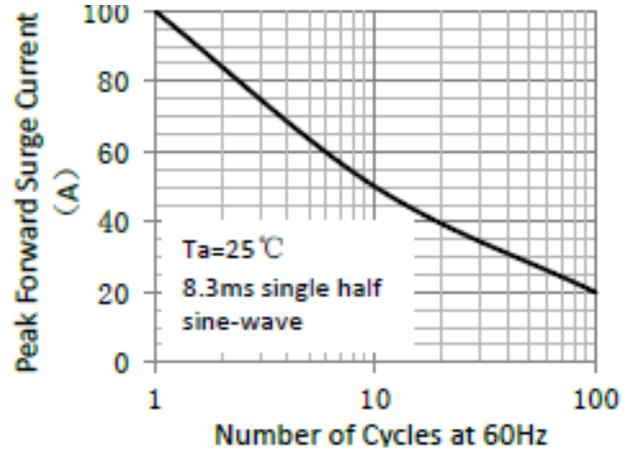


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

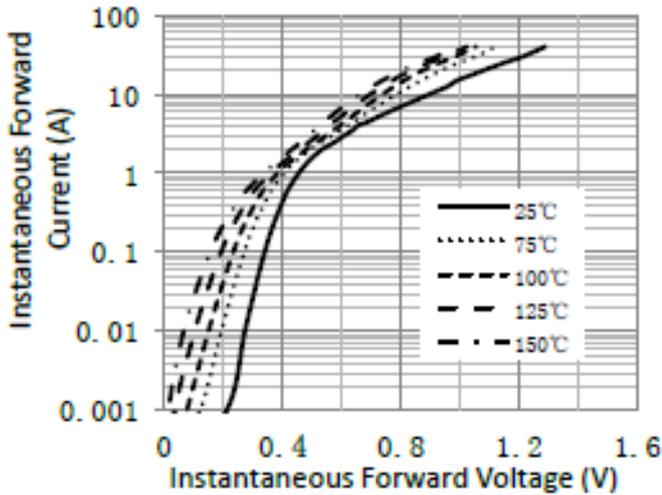


Figure 3. Typical Instantaneous Forward Characteristics

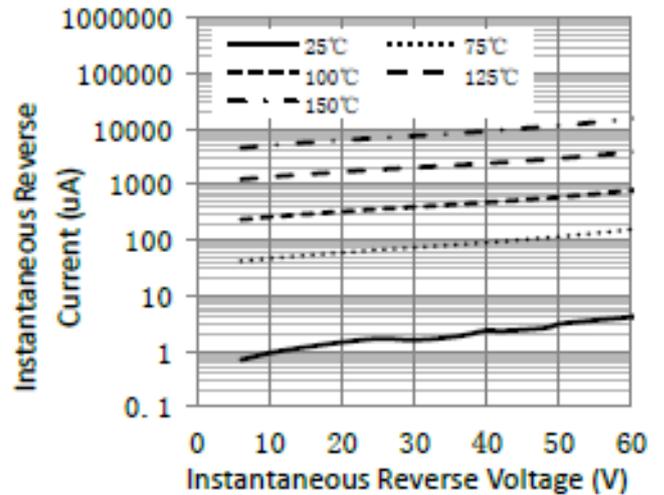


Figure 4. Typical Reverse Characteristics

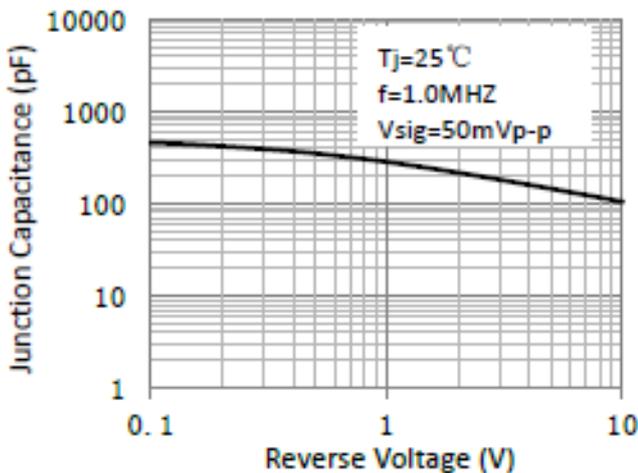
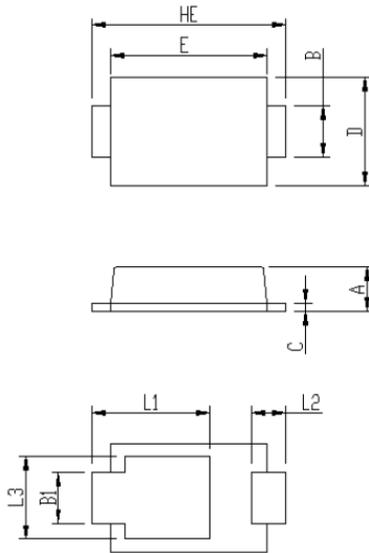


Figure 5. Typical Junction Capacitance

Package Outline Dimensions

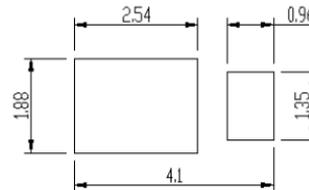
in inches (millimeters)

iSGA (SOD-123HS)



Package	iSGA	
Unit:mm	MIN	MAX
A	0.75	0.90
B	0.85	1.05
B1	0.85	1.05
C	0.1	0.25
D	1.9	2.1
E	2.9	3.1
L1	2.0	2.45
L2	0.4	0.85
L3	1.3	1.7
HE	3.5	3.9

Soldering footprint



Revision History

Document Version	Date of release	Description of changes
Rev.A	2021.06.01	Released Datasheet
Rev.B	2023.10.17	Modify document format

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